IPC ASSOCIATION CONNELECTRONICS INDU	Material Comp © Copyright 2005. I international and Par	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
upplier Inf	formation														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
nsemi												2024-05-19			
Contact Name			Title - Contact			Phone - Co	Phone - Contact*				Email - Contact*				
Product-Env-S	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Rep	presentative*		Title - Representative			Phone - Rep	Phone - Representative*				Email - Representative*				
Product-Env-S	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
Req	quester Item Number	Mfr Item	Number	Mfr Item Name		Effective I	Date '	te Version Manufacturing Site		uring Site	,	Weight*	UOM	Unit Type	
		LV8968BBUWR2G Automo		Automotive Three-	utomotive Three-phase BLDC Gate driver		9		PHG		2	200.0	mg	Each	
Ianufactur	ring Proccess Informa	tion												·	
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MSL		-STD-020 MSL Rating	Peak Process Body Tempera		ture Max	Time at Peak	Temperat	ure Num	ber of Reflow Cyc	eles		
contains Bi			CU Alloy 3			260		C	30		secon	ds 3			
omments															
TTENTION:	: MSL 3 Rated item require	s Bake and D	ry Pack (after	r electrical test)											
or more infor	rmation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	8.49	mg	Supplier	Silicon (Si)	7440-21-3		8.49	mg
Die Attach	0.58	mg	Supplier	Epoxy resins	129915-35-1		0.3335	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.2378	mg
			Supplier	Acrylic resins	Proprietary Data		0.0087	mg
Lead Frame	66.72	mg	Supplier	Zinc (Zn)	7440-66-6		0.1268	mg
			Supplier	Iron (Fe)	7439-89-6		1.728	mg
			Supplier	Copper (Cu)	7440-50-8		64.7718	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0934	mg
Mold Compound-Black	120.3		Supplier	Ortho Cresol Novolac Resin	29690-82-2		9.624	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		3.3684	mg
			Supplier	Carbon Black (C)	1333-86-4		1.203	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		3.609	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		96.24	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		6.015	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.2406	mg
Plating	2.77	mg	В	Bismuth (Bi)	7440-69-9		0.0166	mg
			Supplier	Tin (Sn)	7440-31-5		2.7534	mg
Wire Bond - Au	1.14	mg	Supplier	Gold (Au)	7440-57-5		1.14	mg